

## EAST Search History

## EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	3	"20050021172"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:46
S2	7	(ic (integrated adj circuit)) with (corrugat\$3 adj (board sheet substrate)) with roll	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:48
S3	241	(ic (integrated adj circuit) chip) with (corrugat\$3 adj (board sheet substrate))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:50
S4	9	(ic (integrated adj circuit) chip) with (corrugat\$3 adj (board sheet substrate)) with roll	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:50
S5	14934	235/375,451,492,487,488.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:51
S6	5774	340/5.1,572.1.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:51
S7	20181	S5 S6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:51
S8	2	S3 and S7	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:51

S9	9	((ic (integrated adj circuit) chip) adj tag) with (corrugat\$3 adj (board sheet substrate))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:52
S10	2	"6943678".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:54
S11	223	("20020017745"   "20020020487"   "20020020705"   "3398434"   "3583036"   "3597799"   "3695188"   "3702100"   "3779687"   "3783078"   "3787158"   "3867088"   "3868209"   "3919382"   "3919445"   "3919446"   "3964400"   "4013021"   "4070839"   "4079232"   "4101252"   "4113909"   "4133270"   "4158539"   "4164387"   "4164389"   "4194663"   "4244915"   "4255382"   "4287836"   "4348442"   "4377377"   "4428306"   "4464329"   "4488496"   "4500213"   "4507348"   "4509432"   "4509909"   "4513048"   "4531901"   "4555381"   "4600376"   "4606278"   "4608009"   "4636348"   "4649007"   "4666544"   "4742781"   "4801347"   "4846077"   "4907515"   "4969812"   "5007225"   "5030501"   "5042396"   "5046434"   "5071603"   "5088418"   "5108529"   "5117762"   "5123359"   "5123541"   "5143778"   "5156782"   "5164211"   "5167969"   "5168817"   "5197395"   "5197396"   "5225213"   "5226373"   "5229648"   "5255613"   "5283028"   "5283029"   "5329861"   "5329862"   "5337681"   "5351627"   "5351628"   "5351629"   "5367960"   "5367961"   "5390467"   "5391251"   "5401347"   "5402735"   "5404829"   "5407632"   "5408937"   "5413052"   "5427732"   "5448110"   "5470641"   "5479416"   "5492069"   "5505141"   "5517188"   "5527585"   "5531585"   "5535668"   "5539775"   "5555820"   "5583819"   "5596933"   "5606921"   "5620715"   "5624622"   "5624630"   "5635129"   "5635306"   "5638760"   "5649295"   "5657007"   "5661457"   "5664322"   "5676064"   "5686928"   "5687652"   "5708423"   "5716581"   "5755162"   "5769003"). PN. OR ("5774876"   "5778801"   "5782129"   "5791262"   "5794542"   "5794544"   "5800846"   "5813355"   "5814185"   "5818348"   "5822683"   "5822714"   "5830299"   "5836255"   "5843366"   "5845588"   "5860369"   "5862760"   "5868080"   "5879495"	US-PGPUB; USPAT; USOCR	OR	ON	2010/05/28 10:54

		"5885691"   "5894803"   "5900203"   "5908135"   "5921189"   "5929779"   "5933354"   "5936527"   "5942987"   "5950545"   "5950546"   "5955950"   "5963144"   "5967057"   "5971592"   "5973599"   "5975879"   "5980231"   "5986569"   "5986570"   "5993724"   "5999091"   "6006677"   "6013949"   "6018641"   "6018927"   "6021721"   "6025780"   "6027027"   "6029583"   "6199488"   "6483434").PN. OR ("6943678").URPN.				
S12	807	(ic (integrated adj circuit) chip) same (corrugat\$3 adj (board sheet substrate))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:55
S13	0	S11 and S12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:56
S14	27385	(corrugat\$3 adj (board sheet substrate))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:56
S15	6	S11 and S14	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:56
S16	0	S15 and (ic (integrated adj circuit) chip)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:56
S17	9	((ic (integrated adj circuit)) adj tag) with (corrugat\$3 adj (board sheet substrate))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:10
S18	9	((ic (integrated adj circuit)) adj tag) with (corrugat\$3 adj (board sheet substrate box))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:11

S19	34289	(ic (integrated adj circuit) chip) with attach\$3 with (board sheet substrate medium)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:12
S20	493	S19 and S7	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:12
S21	222003	corrugat\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:12
S22	12	S20 and S21	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:12
S23	2	"20020030597".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 12:08
S24	1	"6943678".pn. and bond\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 15:54
S25	1	((ic (integrated adj circuit)) adj tag) same attach\$3 same (((cardboard (card adj board) box\$2)sheet substrate) medium paper) same ((starch adj past\$3) (vinyl adj acetate adj emulsion))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 15:58
S26	775	((ic (integrated adj circuit)) adj tag) same attach\$3 same (((cardboard (card adj board) box\$2)sheet substrate) medium paper)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 15:59
S27	13475	((starch adj past\$3) (vinyl adj acetate adj emulsion))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 15:59

S28	12	S26 and S27	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 15:59
S29	4	("20030166812"   "20030179093"   "20080202300"   "6368707").PN. OR ("7561047").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2010/05/28 16:05
S30	2	S29 and resin	US-PGPUB; USPAT; USOCR	OR	ON	2010/05/28 16:05
S31	1	"20070241900".pn. and bond\$3	US-PGPUB; USPAT; USOCR	OR	ON	2010/05/28 16:07
S32	1	"20070241900".pn. and (bond\$3 same attach\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2010/05/28 16:22

**EAST Search History (Interference)**

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